

MOSFET

OptiMOS[™] 6 Power-Transistor, 200 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Excellent gate charge x R_{DS(on)} product (FOM)
 Very low reverse recovery charge (Q_{rr})
- · High avalanche energy rating

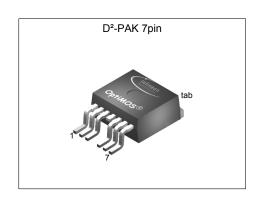
- 175°C operating temperature
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21
- MSL 1 classified according to J-STD-020
- 100% avalanche tested

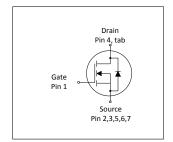


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
$V_{ t DS}$	200	V
$R_{\mathrm{DS(on),max}}$	6.7	mΩ
I_{D}	138	A
Q _{oss}	227	nC
Q _G	72	nC
Q _{rr} (1000A/µs)	364	nC











Type / Ordering Code	Package	Marking	Related Links
IPF067N20NM6	PG-TO263-7	067N20N6	-

OptiMOS[™] 6 Power-Transistor, 200 V IPF067N20NM6



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OptiMOS[™] 6 Power-Transistor, 200 V IPF067N20NM6



Rev. 2.0, 2023-12-07

1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamastan	O b. a.l	Values			Unit		
Parameter	Symbol	Min.	Тур.	Тур. Мах.		Note / Test Condition	
Continuous drain current ¹⁾	I _D	- - -	- - -	138 97 101 15.4	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =15 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =40°C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	552	Α	<i>T</i> _C =25 °C	
Avalanche energy, single pulse ⁴⁾	E AS	-	-	506	mJ	$I_{\rm D}$ =76 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	300 3.8	W	T _C =25 °C T _A =25 °C, R _{thJA} =40 °C/W ²⁾	
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	-	

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	0.32	0.5	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area²)		-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	R _{thJA}	-	-	62	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

OptiMOS[™] 6 Power-Transistor, 200 V IPF067N20NM6



3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

D	0		Values			N	
Parameter	Symbol	Min.	. Тур. Мах.		Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	200	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	V _{GS(th)}	3.0	3.7	4.5	V	$V_{\rm DS}$ = $V_{\rm GS}$, $I_{\rm D}$ =253 μ A	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =160 V, V _{GS} =0 V, T _j =25 °C V _{DS} =160 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	5.8 5.1	6.7 6.2	mΩ	V _{GS} =10 V, I _D =100 A V _{GS} =15 V, I _D =100 A	
Gate resistance	R _G	-	2.8	-	Ω	-	
Transconductance ¹⁾	g fs	32	65	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 100 A$	

Table 5 Dynamic characteristics

Parameter	Oh a l	Values			11	Nata / Tank Oam dition
Parameter	Symbol		Тур.	Max.	Unit	Note / Test Condition
Input capacitance	C _{iss}	-	5600	7300	pF	V _{GS} =0 V, V _{DS} =100 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	900	1200	pF	V _{GS} =0 V, V _{DS} =100 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	29	51	pF	V _{GS} =0 V, V _{DS} =100 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	17	-	ns	$V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =3 Ω
Rise time	t _r	-	21	-	ns	$V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =3 Ω
Turn-off delay time	$t_{ m d(off)}$	-	30	-	ns	$V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =3 Ω
Fall time	t _f	-	12	-	ns	$V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =3 Ω

Table 6 Gate charge characteristics²⁾

Domeston	Ole al		Values			Nata / Tank Oan dition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q _{gs}	-	37	-	nC	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge at threshold	$Q_{g(th)}$	-	21	-	nC	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge ¹⁾	$Q_{ m gd}$	_	14	21	nC	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q _{sw}	-	31	-	nC	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total ¹⁾	Qg	-	72	108	nC	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	V _{plateau}	-	6.7	-	V	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total, sync. FET	Q _{g(sync)}	-	62	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V	
Output charge ¹⁾	Qoss	_	227	295	nC	V _{DS} =100 V, V _{GS} =0 V	

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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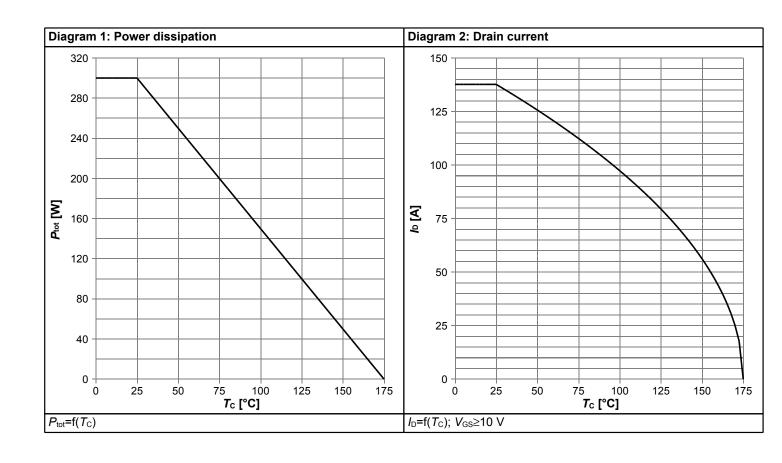


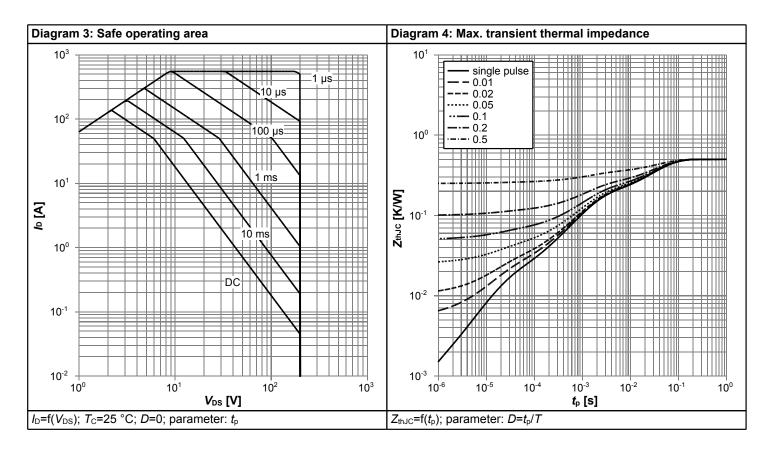
Table 7 Reverse diode

Dougnatou	Cumbal		Values			Nata / Taat Canditian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	138	Α	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	552	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.90	1.0	V	V _{GS} =0 V, I _F =100 A, T _j =25 °C	
Reverse recovery time	t _{rr}	-	58	-	ns	V _R =100 V, I _F =50 A, di _F /dt=100 A/μs	
Reverse recovery charge ¹⁾	Qrr	-	67	134	nC	V _R =100 V, I _F =50 A, di _F /dt=100 A/μs	
Reverse recovery time	t _{rr}	-	36	-	ns	V _R =100 V, I _F =50 A, di _F /dt=1000 A/μs	
Reverse recovery charge ¹⁾	Qrr	-	364	728	nC	V _R =100 V, I _F =50 A, di _F /dt=1000 A/μs	

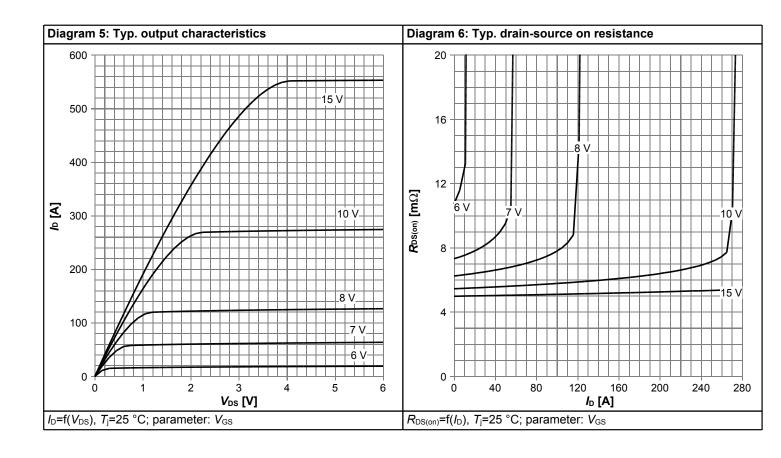


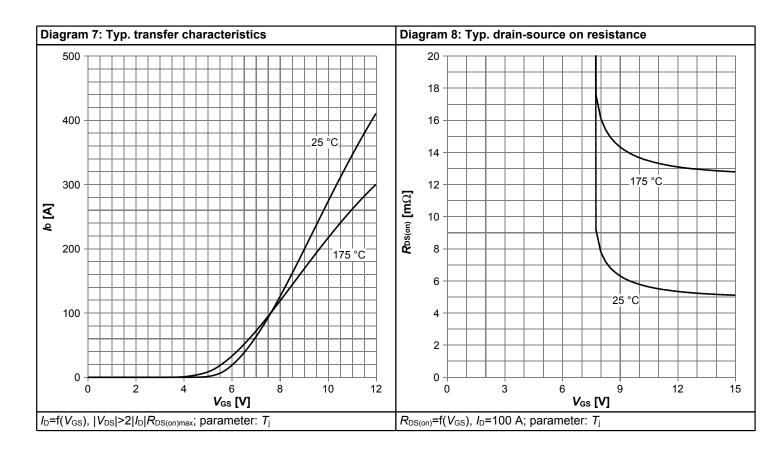
4 Electrical characteristics diagrams



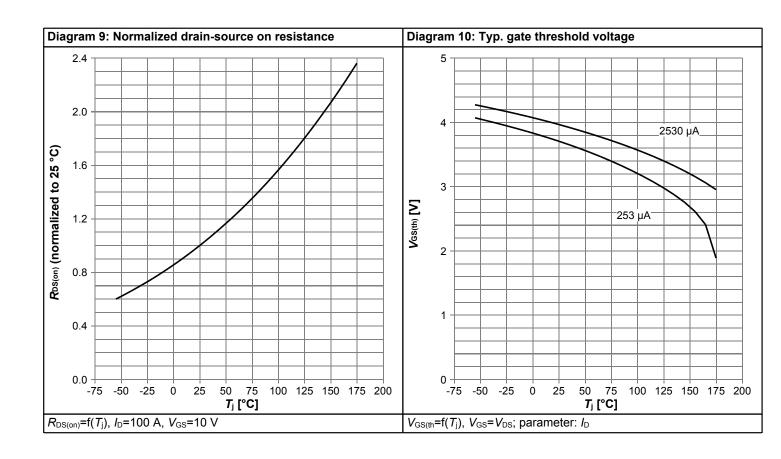


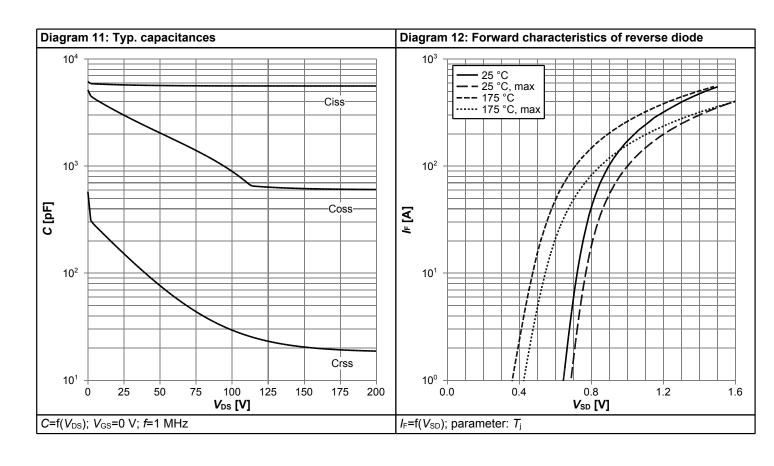




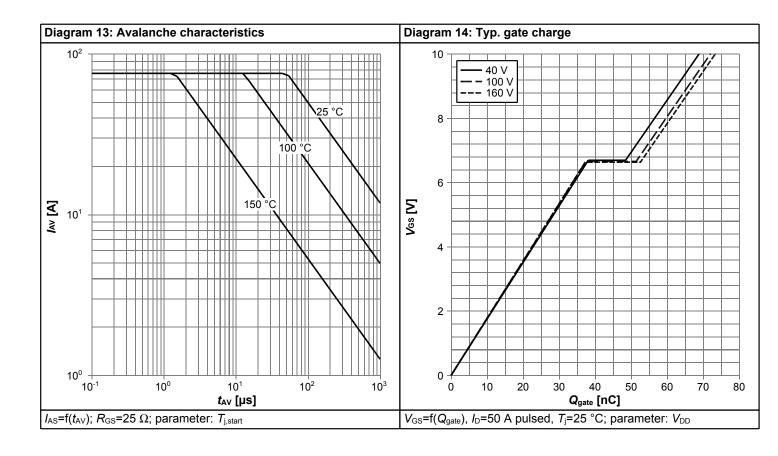


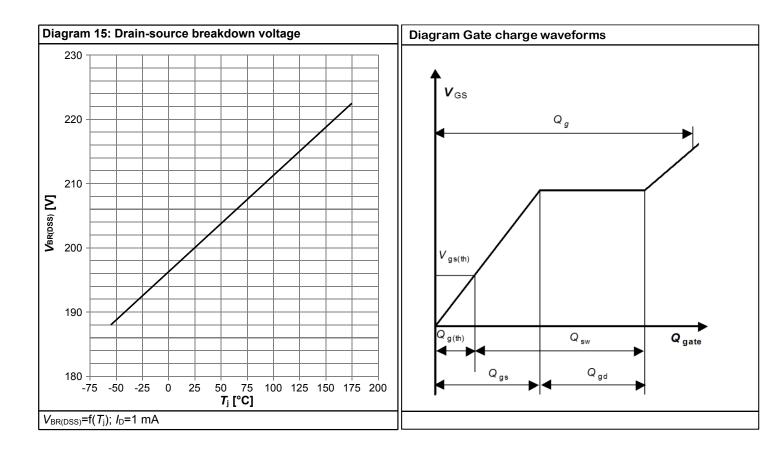






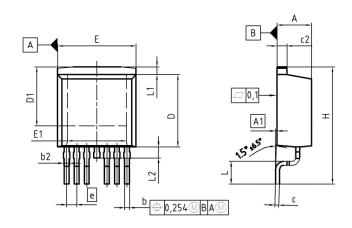


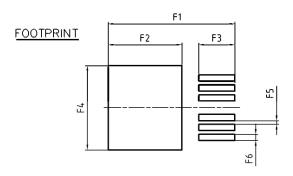






5 Package Outlines





DIM	MILLIM	IETERS	INC	HES	
DIM	MIN MAX		MIN	MAX	
Α	4.30	4.57	0.169	0.180	
A1	0.00	0.25	0.000	0.010	
Ь	0.50	0.70	0.020	0.028	
b2	0.50	1.00	0.020	0.039	
С	0.33	0.65	0.013	0.026	
c2	1.17	1.40	0.046	0.055	
D	8.51	9.45	0.335	0.372	
D1	6.90	7.90	0.272	0.311	
E	9.80	10.31	0.386	0.406	
E1	6.50	8.60	0.256	0.339	
е	1.	27	0.050		
N		6		6	
Н	14.61	15.88	0.575	0.625	
L	2.29	3.00	0.090	0.118	
L1	0.70	1.60	0.028	0.063	
L2	1.00	1.78	0.039	0.070	
F1	16.05	16.25	0.632	0.640	
F2	9,30	9.50	0.366	0.374	
F3	4.50	4.70	0.177	0.185	
F4	10.70	10.90	0.421	0.429	
F5	0.37	0.57	0.015	0.022	
F6	0.70	0.90	0.028	0.035	

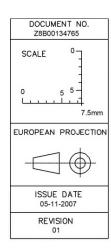


Figure 1 Outline PG-TO263-7, dimensions in mm/inches

OptiMOSTM 6 Power-Transistor, 200 V



Revision History

IPF067N20NM6

Revision: 2023-12-07, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)			
2.0	2023-12-07	Release of final version			

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Final Data Sheet 11 Rev. 2.0, 2023-12-07